

[420_{v1}] LAYING FLOOR COVERINGS WITH ELECTRICAL PROPERTIES, USING GTI EL5 CLEANTECH TILES WELDED WITHOUT SKIRTING



Ambient temperature
Minimum: 10° C



Substrate temperature
Minimum: 10° C

Before laying the floor covering, it should be inspected, so as to detect any visual defects. In the event of any visual defects, please notify GERFLOR and do not start laying the product before receiving GERFLOR's approval.

MATERIALS	FORMAT	CODE	NOTES
GTI EL5 CLEANTECH	650 x 650 / Th 6 mm	2714 followed by colour code	
Copper strip	W (width) 10 mm / Th 0.08 mm	0586 0001	self tape copper strip is not permitted
Conductive welding rod	100 ml	2722 followed by colour code	
Tackifier or acrylic glue	Any make of acrylic glue		

ANTISTATIC ASTATIC FLOORINGS (ASF) < 2 kW

Standard installation. These floorings do not require any specific installation method (no copper strip required)

DISSIPATIVE (DIF) AND CONDUCTIVE (ECF) FLOORINGS

Installation using a tackifier or acrylic glue only under the axis + copper strip: code 0586 0001 (length: 200 ml)
Store the tiles for 24 hours in the room where they will be installed.

REQUIREMENT SPECIFICATION FOR CONDUCTIVE FLOORINGS:

It is the responsibility of the client and/or contractor to set out the applicable standard in the requirement specification.

METHODS FOR RESILIENT FLOOR COVERINGS:

Europe: EN 1081. Transversal resistance and surface resistance on tripod
USA: ASTM F150 /NFPA 99 (2 cylindrical electrodes)

METHODS FOR ELECTRICAL INDUSTRIES:

Europe: CEI 61340-4-1
USA: ANSI/ESD S 7.1
For all other methods, see technical datasheet of the flooring.

1. CHOICE OF JOINT TREATMENT

This material is laid edge to edge, **with or without** coving. For the installation of GTI EL5 cleantech with coving, see Installation Guidelines [421].

WATER EXPOSURE	JOINT AND EDGE TREATMENT
Room exposed to water (bathrooms, kitchens)	Joints heat-welded + caulked at the edges (leave a 3mm gap to apply mastic)*
Room with a prolonged exposition to water	Joints heat-welded + coving

See installation guidelines [501] "tiles and rolls welding". * Skirting must be installed after the flooring is laid.

2. LAYING

Preparation

The tiles must be stored in the room in which they are going to be laid for 24 to 48 hours before installation. After installation, the temperature variation must not exceed 20 °C.

SUBSTRATE: Moisture content 4% at 4 cm with a carbide bomb test. To guaranty good conductivity between tiles, ensure that the surface evenness is < 7 mm under a 2m straight edge and < 2 mm under a 20 cm straight edge, with no unevenness.

MECHANICAL PREPARATION: The surfaces should be prepared with care so as to remove any soiling, laitance, treatment products or any other foreign bodies.

BUMP AND DEPRESSION TREATMENT: Sanding of bumps. Point levelling of depressions with a suitable floor sealer.

CRACK TREATMENT: On any surface, cracks should be detected beforehand. They are not treated if there is no unevenness and if they are < 3 mm wide.

JOINT TREATMENT: Contraction joint: if gap < 4 mm, they are not treated. Structural Expansion Joint: following thorough cleaning, expansion joints are preserved: end profiles with or without an overlay

are arranged on either side of the joint. Construction joint: similar to cracks, not treated if gap < 3 mm.

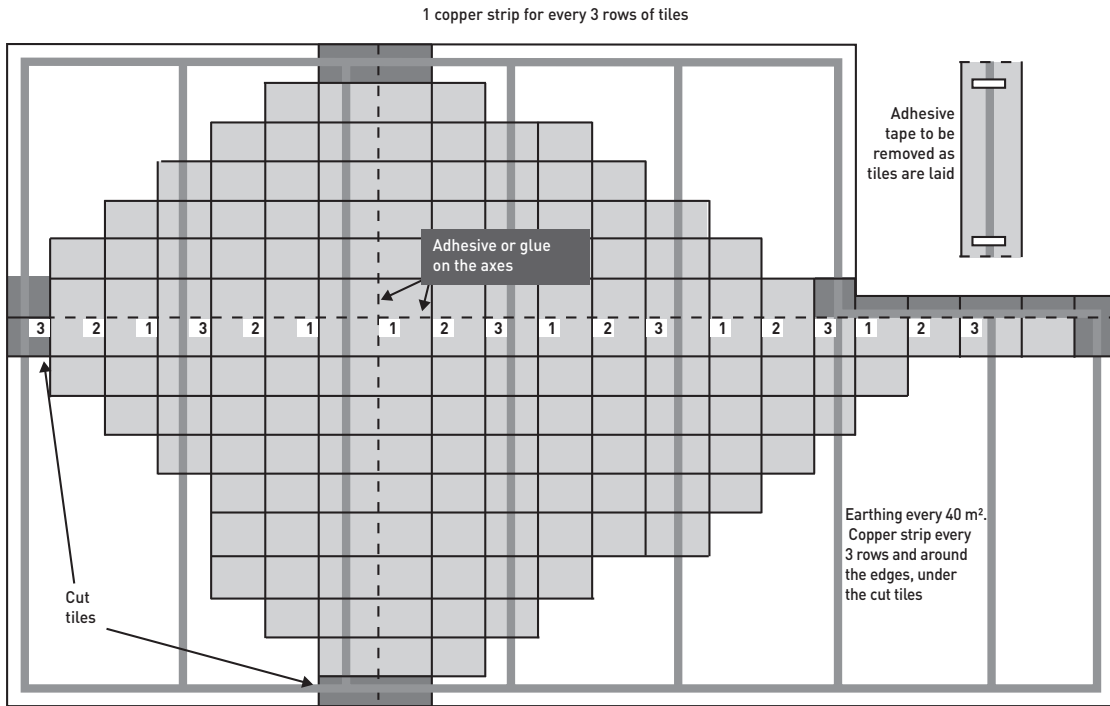
LOCALISED LEVELLING: Surface levelling may be required, particularly where the surface is not sufficiently even or in poor condition.

■ 2.1 - MARKING OUT AND LAYING THE STRIPS

- Mark out the two perpendicular axes, making sure the cuts are the same on each side
- Use a roller to apply the tackifier or acrylic glue evenly over the two axes with a coverage of about 100 to 150 g/m².
- Respect the waiting time according to the manufacturer's instructions.
- Install one copper strip for **every 3 rows, in one direction**, holding it down with adhesive tape (see diagram)
- **Encircle the room with a copper strip under the cut tile at least 5 cm from the walls**
- An earthing line must be provided for every 40 m². Leave 50 cm of the strip spare to allow the electrician to make the connection
- The copper strip might be located later with remote imaging.

Self tape copper strip is not permitted.

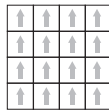
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2.2 - LAYING THE TILES

• Precautions

- 1- The tiles are supplied on pallets. Different batches must not be mixed together
- 2- Laying direction: Tiles are ALL laid in the same direction. Observe the direction indicated by the area on the back of the tile.
- 3- Pressed materials, such as GTI tiles, may have dimensional tolerances between series or between colours. In this case, the tiles can become slightly offset. It is therefore necessary to cross-cut the entire row of tiles before continuing the laying. These two rows will be hot-welded

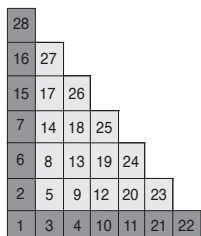


- take the tile you want to cut and mark along the edge of the template, using a knife with a straight blade
- cut the tile cleanly then put it in place
- to help, you are recommended to heat the material with a hot-air paint stripper
- this method means that no jigsaw is necessary

4- To make the welding process easier, it is possible to maintain the tiles with adhesive. In this case, the adhesive must be applied before the positioning of the copper strips.

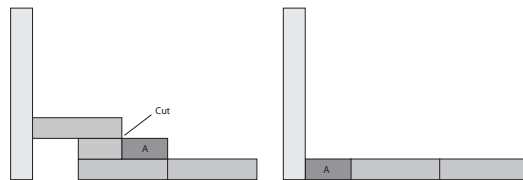
More difficult cuts (door frames, etc.) may be made using a jigsaw or high leverage nippers. If there is a lot of cutting, we recommend keeping a circular saw on site.

When planning the edge cuts, make sure that they are the same on each side and that the tiles are not cut to less than half the width of a tile plus caulking gap (see drawing).



Lay the first tile and continue in a staircase pattern, following the axes you marked out. The tiles must be in contact by their backside. Remove the adhesive tape from the strip as you work. The copper strip must always be in direct contact with the back of the tiles.

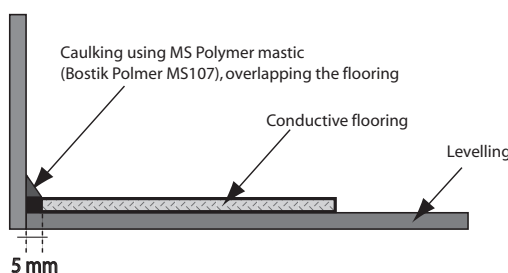
- Tiles laid to guidelines
- Order of laying other tiles



2.3 - EDGING

Cuts are made:

- Either using a cutter (make one or two marking cut on the surface before snapping the tile)
- Or by scribing : method for drawing or cutting parallel lines. A scribe device or an uncut tile can be used :
 - place the tile being cut on the last uncut tile of the row
 - take an uncut tile to act as a template
 - place it on the tile you want to cut, pushing it against the partition (wall)
 - leave a gap of 5 mm



FLOORS IN BUILDINGS

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2.4 - HOT WELDED JOINTS

The tile joints are welded with a two-layer conductive seam.

The two-layer conductive seam leaves a black thread after levelling. This thread provides conductivity between each tile.

IMPORTANT:

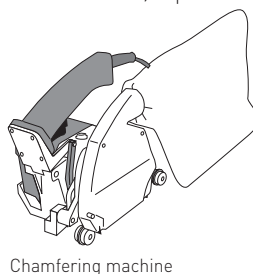
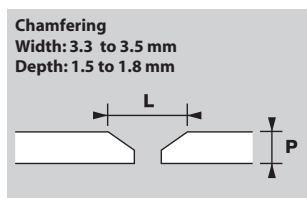
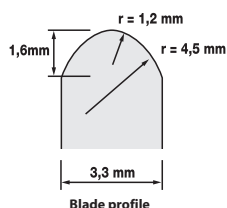
- The tiles are not supplied chamfered, but bevelled as a guide for the chamfering tool.
- The removed two-layer conductive seam may leave marks on the flooring. You are recommended to collect the removed pieces as you work.
- To prevent poor welds where the tiles intersect, it is necessary to chamfer, weld and level in one direction before repeating in the other direction.

To avoid calamine deposits during the welding process, we recommended the following:

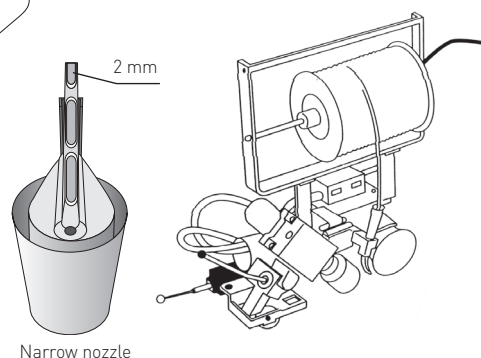
- Stay within the temperature range 400 – 500°
- Follow the recommended speed: Position 3
- Clean the nozzles regularly

2.4.1 Chamfering

- **Chamfer the joints** using an electric chamfering machine, blade width 3.3 mm, depth 1.5 to 1.8 mm
- Use a triangular grooving tool to chamfer along the skirting



Chamfering machine



Narrow nozzle

2.4.2 Welding

- **Hot weld the joints** using a welding machine.

Use a LEISTER UNIVERSAL or UNIFLOOR hot air welding machine with electronically controlled heating, fitted with a narrow multi-outlet nozzle designed for this purpose.

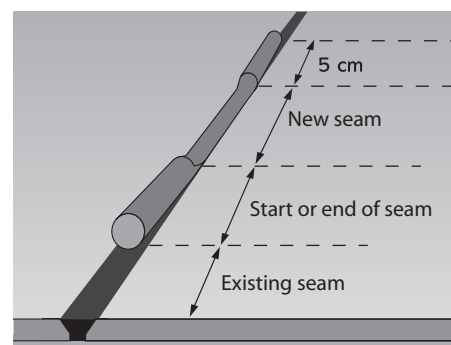
TOOLS	ROMUS CODE	JANSER CODE	LEISTER CODE
Narrow nozzle	95254	225 860 040	105 407

- **A Leister Triac S handheld hot air tool must be used at the start and end of the weld**

Joining or repairing welds

To prevent carbon black build-up during repairs:

- Make an initial levelling cut of the seam.
- Clean the joint with a vacuum cleaner to remove the particles and run a triangular scraper over it.
- Make a notch at both ends of the seam.
- Use a hot air tool with the Rapid nozzle as explained above, starting and ending at the existing welds (about 5 cm).



2.4.3 Levelling the seams

- Using a MOZART knife:

First pass: make an initial cut by placing the levelling guide under the MOZART knife blade (fig. 1)

Second pass: allow the seam to cool down completely

Rotate the levelling guide to 90° on the side and make a second pass to completely remove the excess seam material (fig. 2)

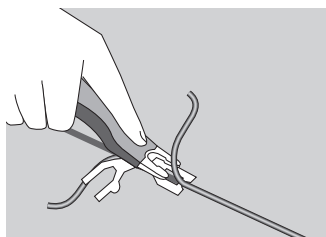
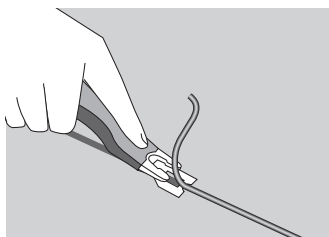


Fig. 1 - Levelling guide under the blade

Fig. 2 - Levelling guide at 90°

TOOLS	GERFLOR CODE
MOZART knife	0561 0001
Spare blades	0542 0001

This method prevents hollow welds.

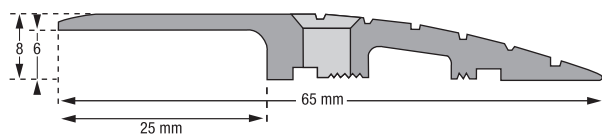
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3. CORNERS AND DOORWAYS

3.1 - ENDS AND DOORWAYS

Use the following profiles depending on conditions of use: traffic, humidity, etc.

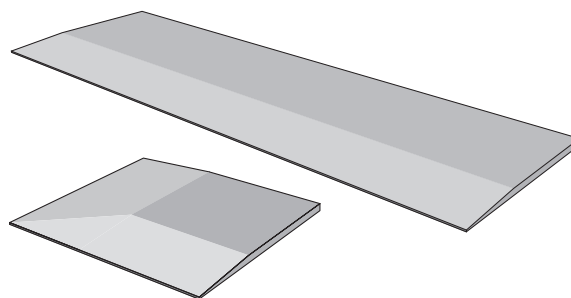
3.1.1 Heavy traffic, pallet trucks...



Finishing profile H 0505

3.1.2 Moderate traffic

GTI EL5 CLEANTECH ACCESS AND CORNER		
GTI EL5 CLEANTECH ACCESS	635 x 320 mm	Code: 2715 followed by colour code
GTI EL5 CLEANTECH CORNER	320 x 320 mm	Code: 2716 followed by colour code



These accessories must be glued down, either using a 2 components PU adhesive and weighted until the adhesive sets (6 to 12 hours), or using an acrylic double bonding adhesive.

4. FIRST USE

For normal traffic, the floor can be walked on immediately after welding.
To move furniture, lay panels to distribute the load.
Do not allow rubber feet to be used on furniture.

5. UNDERFLOOR HEATING

Underfloor heating should be turned up gradually over the seven days after the flooring is laid.

6. MAINTENANCE

FINAL CLEANING

The floor covering can be used as soon as it is laid, but take these precautions:

- Deposits or scuffing remains from the seam : dampen a clean cloth with alkaline detergent and gently rub to clean the marks, then wipe with a sponge dampened with clean water.

DO NOT ATTEMPT TO CLEAN BY HAND OR USING A DRY CLOTH

- After the marks are removed, flooring must be cleaned as follows:
- Remove dust and particles using a broom or an industrial vacuum cleaner,
 - Clean the floor with a scrubber drier using an alkaline detergent,
 - Rinse with clean water to remove all traces of the detergent,
 - Let it dry.

DAILY CARE

Refer to the care sheet for the product.